In September 1995, Altera announced in PCN 9510 the transition schedule for its Classic product family to a 0.65-micron process. This change improves Altera’s ability to support the Classic product family on a long-term basis. No changes to Classic product data sheet parameters or ordering codes are expected to result from this process migration.

The transition of the EP6xx products to the 0.65-micron process will begin on May 1, 1996. The EP9xx products are scheduled to transition on September 1, 1996, while the EP18xx products are scheduled to transition on March 1, 1997. After these dates, Altera may use either existing die, or 0.65-micron die, in product shipments.

Please note that the 0.65-micron process may be distinguished by the fourth digit character of the nine character lot number, which is marked on the backside of the device. The 0.65-micron process is identified by a 7.

If you have any questions or require additional information regarding the changes described herein, please contact your local Altera sales representative.